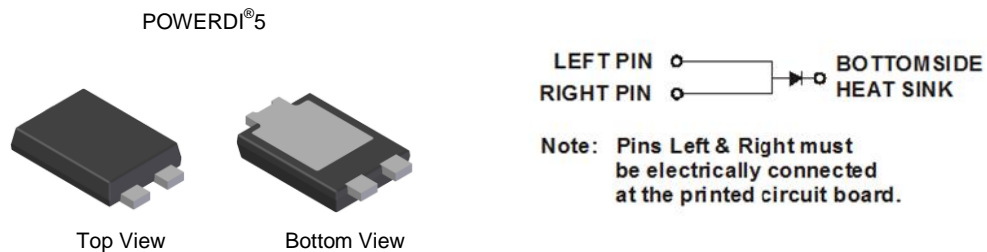


Features

- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +175°C Operating Junction Temperature
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: POWERDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 [Ⓔ]
- Polarity: See Diagram
- Weight: 0.093 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
SBR10U200P5-13	POWERDI [®] 5	5,000/Tape & Reel
SBR10U200P5Q-13	POWERDI [®] 5	5,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

POWERDI[®]5



S10U200 = Product Type Marking Code
 D11 = Manufacturers' Code Marking
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 15 for 2015)
 WW = Week Code (01 - 53)
 K = Factory Designator

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	200	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current	I _O	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	A
Repetitive Peak Avalanche Power (1μs, +25°C)	P _{ARM}	3,000	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	70	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	14	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	20	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	3	°C/W
Operating Temperature Range	T _J	-65 to +175	°C
Reverse Mode DC Forward Mode (Note 7)		≤200	
Storage Temperature Range	T _{STG}	-65 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.75	0.82	V	I _F = 5A, T _J = +25°C
		—	0.62	0.67		I _F = 5A, T _J = +125°C
		—	0.83	0.88		I _F = 10A, T _J = +25°C
Leakage Current (Note 8)	I _R	—	—	0.1	mA	V _R = 200V, T _J = +25°C
			0.18	10		V _R = 200V, T _J = +125°C

- Notes:
5. Device mounted on FR4 PCB with minimum recommended pad layout per <http://www.diodes.com>.
 6. Device mounted on FR4 PCB with 1-inch pad layout and additional HK2(45mm x 20mm x12mm).
 7. Max junction temperature guaranteed for 2 hours.
 8. Short duration pulse test used to minimize self heat effect.

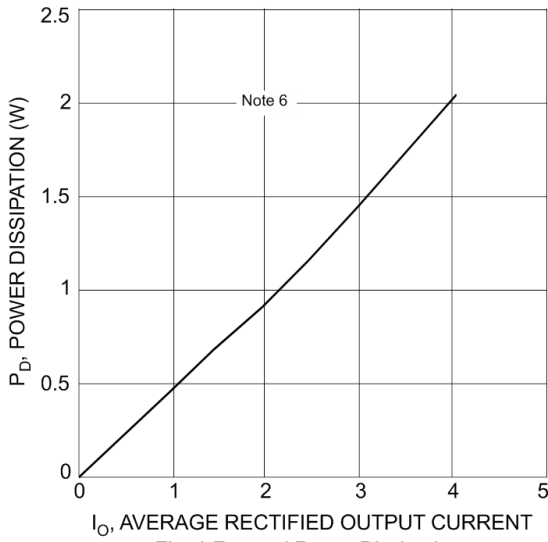


Fig. 1 Forward Power Dissipation

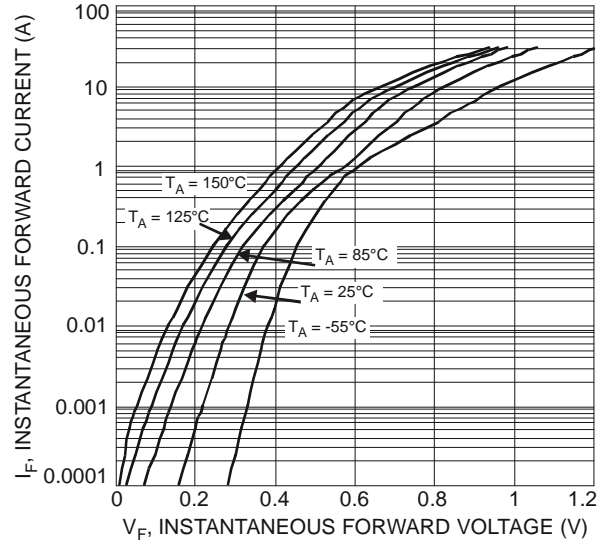


Fig. 2 Typical Forward Characteristics

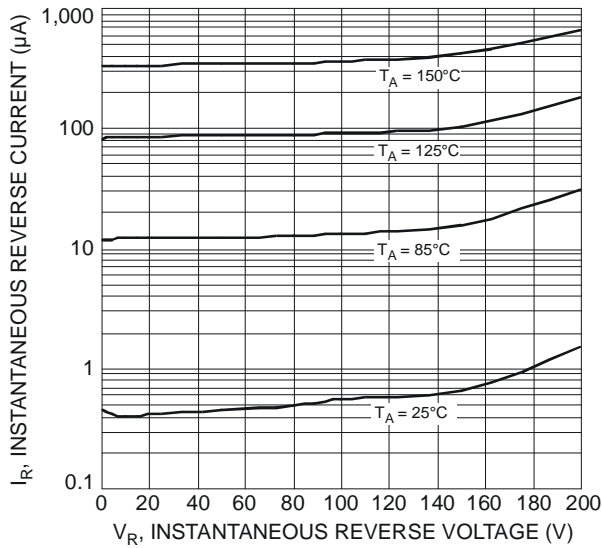


Fig. 3 Typical Reverse Characteristics

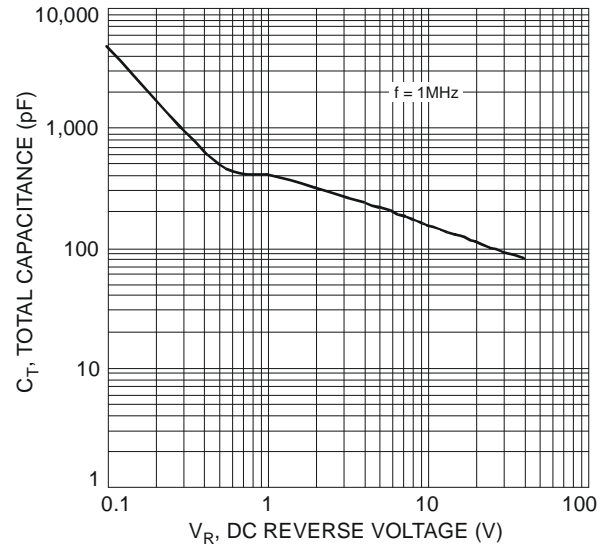


Fig. 4 Total Capacitance vs. Reverse Voltage

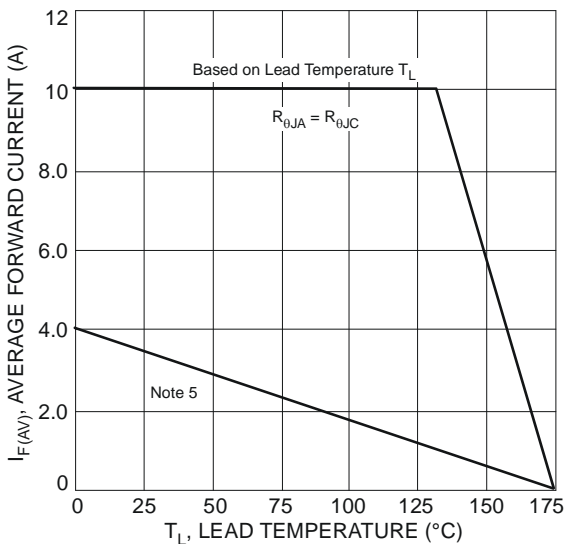


Fig. 5 Forward Current Derating Curve

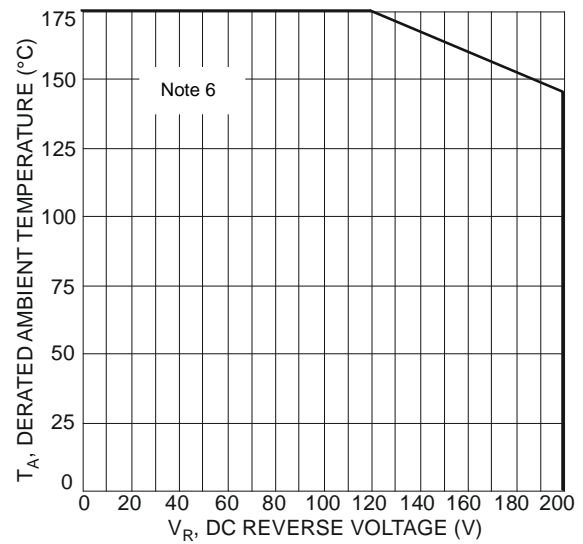


Fig. 6 Operating Temperature Derating

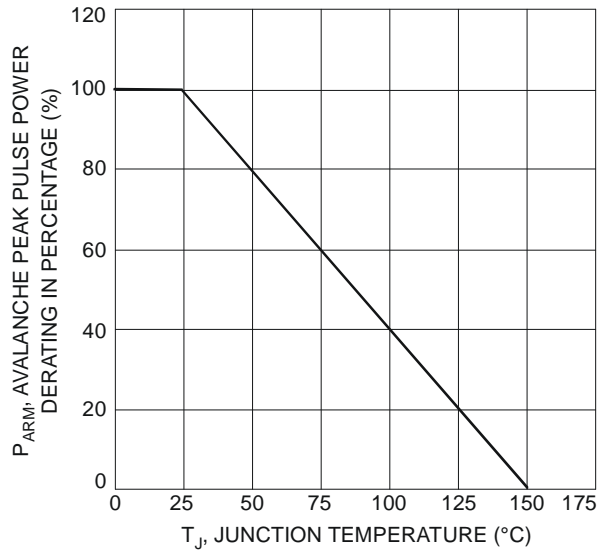


Fig. 7 Pulse Derating Curve

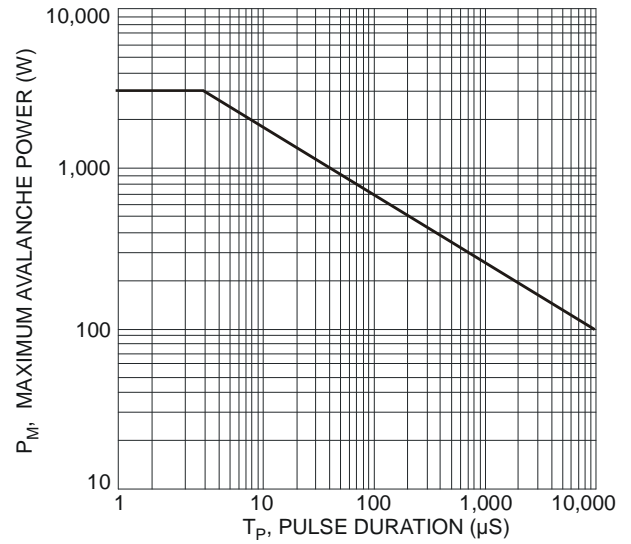
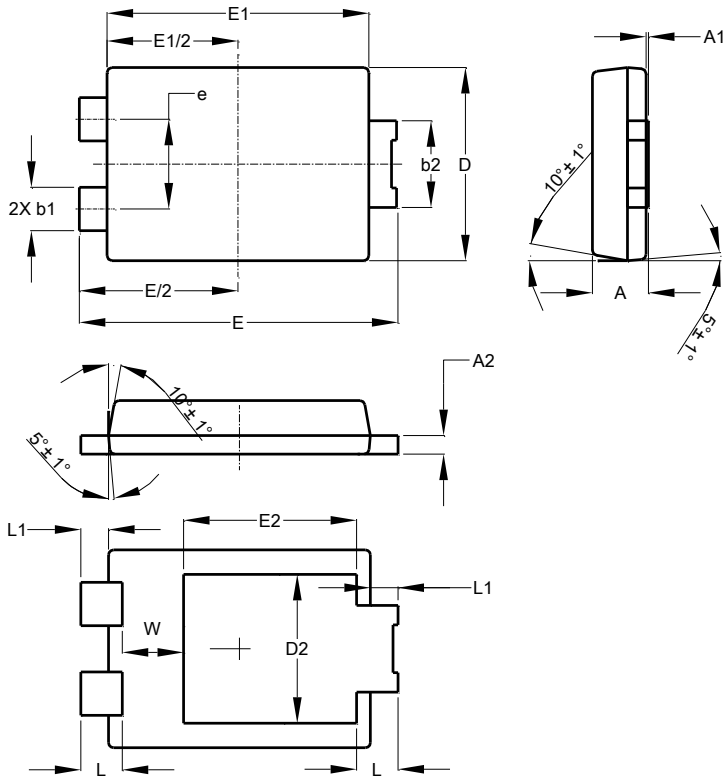


Fig. 8 Maximum Avalanche Power vs. Pulse Duration

Package Outline Dimensions

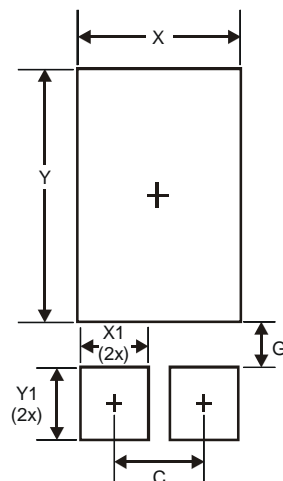
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



POWERDI [®] 5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	-	-	3.054
E	6.40	6.60	6.504
e	-	-	1.84
E1	5.30	5.45	5.37
E2	-	-	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400

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